

# Spatial Resolution of the Belle II Silicon Vertex Detector

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The Belle II experiment at the SuperKEKB collider in Japan will search for new sources of CP violation and indirectly probe new physics by studying the suppressed decays of beauty mesons, charm mesons and tau leptons. In these pursuits, the spatial resolution of the Belle II Silicon Vertex Detector (SVD) will play a key role. We report herein the spatial resolution of the SVD using simulated data for a simplified version of the Belle II detector.

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#### 1. Introduction

Belle II at SuperKEKB in Tsukuba, Japan will search for new sources of CP violation and signatures of new physics by studying the suppressed decays of beauty mesons, charm mesons and tau leptons. The experiment is located at an interaction point of the SuperKEKB  $e^+e^-$  collider, which is operating at a center-of-mass energy near the  $\Upsilon(4S)$  resonance. The positron and electron beams have unequal energies of 4 and 7 GeV, respectively, which make the  $\Upsilon(4S)$  boosted in the lab frame with a Lorentz factor  $\beta\gamma=0.28$  that is about two-thirds of that in Belle. The SuperKEKB, aims to deliver collision data at an unprecedented luminosity of  $8\times10^{35}$  cm $^{-2}$ s $^{-1}$ , 40 times higher than its predecessor (KEKB), by a sizable decrease in the beam cross-section and a moderate increase in the beam current.

At Belle II, the precise determination of decay vertex and low-momentum tracking are crucial to indirectly probe new physics. The reconstruction of charged particles near the interaction point is accomplished by a six-layer VerteX Detector (VXD), which consists of two layers, layer 1 and 2, of PiXel Detector (PXD) at radii 1.4 and 2.2 cm, and four layers, layer 3 to 6, of Silicon Vertex Detector (SVD) at radii 3.9, 8.0, 10.4 and 13.5 cm. The PXD and SVD are comprised of depleted p-channel field effect transistor pixel sensors and Double-sided Silicon Strip Detectors (DSSDs), respectively. The lower  $\beta \gamma$  factor causes a smaller separation between the two B mesons compared to Belle; however thanks to a thinner beam pipe, the VXD is nearer to the interaction point and as a consequence, the SVD along with the PXD gives a better vertex measurement than Belle.

#### 2. The Silicon Vertex Detector

The Belle II SVD consists of a number of DSSD sensors that are cylindrically arranged around the interaction point. Each DSSD sensor is either rectangular or trapezoidal having  $300-320~\mu m$  thickness with n-type bulk whose one side is doped by acceptor (called strips) and the other side is doped by donor, with strips being perpendicular to the former. The acceptor implanted side, called p or U side, having longer strips parallel to the length of the sensor, measures the  $r-\phi$  coordinate. The donor implanted (n or V side) shorter strips measure the z coordinate. Layer-3 sensors have readout pitch 50  $\mu$ m in the  $r-\phi$  plane and 160  $\mu$ m along the z axis. On the other hand, layer-4, 5 and 6 sensors have readout pitch 75  $\mu$ m in the  $r-\phi$  plane and 240  $\mu$ m along the z axis. To improve the spatial resolution, one floating strip is implemented between two readout strips. A detailed description of the SVD can be found in Ref. [1].

# 3. Phase-2 Monte Carlo Samples

For the measurement of spatial resolution we use  $e^+e^- \to \mu^+\mu^-$  events. About 500 pb<sup>-1</sup> of  $e^+e^-$  collision data, corresponding to 0.6 million dimuon events, were collected between February–June 2018 during the Phase-2 running of Belle II which included a partial VXD with rest of the subdetectors fully installed. We report here the measurement of spatial resolution on a simulated

data sample of 5.0 million  $e^+e^- \to \mu^+\mu^-$  events. This study on simulated events has been performed to optimise and validate the procedure that will be later repeated on data.

A track is reconstructed with hits from the tracking subdetectors, namely PXD, SVD and Central Drift Chamber (CDC). To remove potential bias, we exclude hits of the SVD layer for which we wish to determine the spatial resolution. The projection of SVD hits on either side is called SVD cluster. An SVD cluster is reconstructed using serial strips whose signal-to-noise ratio is greater than 5. The cluster position is given by the charge-weighted strip position. Two additional requirements are imposed for selecting the track: the hits associated with the track must contain at least one layer PXD hit and one layer SVD hit.

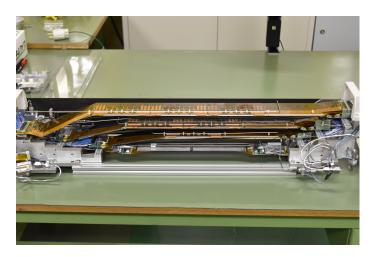


Figure 1: Phase-2 VXD subdetector, with one ladder per layer, is resting on a table before installation. The innermost layers, PXD layers 1 and 2, and SVD layer 3 are barely visible.

### 4. Measurement of Spatial Resolution

The spatial resolution of each sensor is extracted from the residual distribution, where the residual is the difference between the measured hit position and the position of track extrapolated to the sensor plane or the intercept position. The residual distribution has contributions from the uncertainty associated to the hit position (the spatial resolution),  $\sigma_{hit}$  and the uncertainty of the intercept position,  $\sigma_{track}$ . We can safely assume, at first order, that the hit position and intercept position are not correlated, and  $\sigma_{hit}$  is calculated as the square root of the quadrature difference between  $\sigma_{res}$  and  $\sigma_{track}$  i.e.,

$$\sigma_{
m hit} = \sqrt{(\sigma_{
m res})^2 - (\sigma_{
m track})^2},$$

where  $\sigma_{res}$  is the residual distribution width. The residual width is extracted by fitting the residual distribution with a sum of two Gaussian functions of common mean and then calculating the weighted average of the Gaussian widths with the relative fraction of events fitted with each Gaussian

sian. The fit function is given by

$$f(x) = \frac{s}{\sqrt{2\pi}\sigma_1}e^{-\frac{(x-\mu)^2}{2\sigma_1^2}} + \frac{1-s}{\sqrt{2\pi}\sigma_2}e^{-\frac{(x-\mu)^2}{2\sigma_2^2}},$$

where  $\mu$  is the common mean,  $\sigma_1$  and  $\sigma_2$  are the widths of two Gaussians, and s is the fraction of the first Gaussian. Thus, the effective width is  $\sigma^2 = s\sigma_1^2 + (1-s)\sigma_2^2$ . The error on track extrapolation or  $\sigma_{\text{track}}$  is returned by the Kalman filter used to extrapolate the track to the sensor plane.

Figure 2 is an example of the residual distribution for the central sensor of the 6th layer, for clusters composed of a single strip.

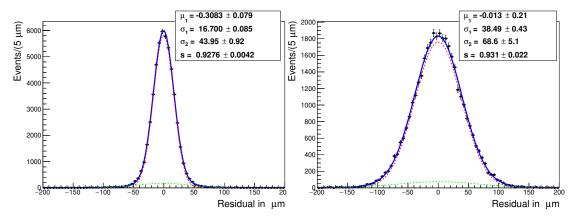


Figure 2: Residual distribution for the 6<sup>th</sup> layer U-side (left) and V-side (right) with cluster size one.

Using the simulated sample, we find that the  $\sigma_{track}$  value returned by the extrapolation is underestimated, therefore we calculate  $\sigma_{track}$  using the true position of the intercept of the track with the sensor. Basically, we fit the distribution of true residual i.e., the difference in the intercept and true-hit position, to the sum of two Gaussian functions with common mean, and take its effective width as  $\sigma_{track}$  (as described earlier). We will follow the same procedure for real data, except that as we do not have truth information there, the estimated truth information from the MC sample can be used. The statistical uncertainty associated to  $\sigma_{hit}$  is

$$\sqrt{\left\lceil\frac{\sigma_{res}}{\sigma_{hit}}\delta(\sigma_{res})\right\rceil^2 + \left\lceil\frac{\sigma_{track}}{\sigma_{hit}}\delta(\sigma_{track})\right\rceil^2},$$

with  $\delta(\sigma_{\rm res})$  and  $\delta(\sigma_{\rm track})$  being obtained from the fitting.

		Readout	Digital	$\sigma_{ m hit}$ in $\mu m$	
Layer	Side	pitch (p)	resolution		
		in $\mu m$	$=\frac{p}{2\sqrt{12}}$	for cluster size	
			in $\mu m$	one	two
3	U	50	7.21	$5.78\pm0.12$	$5.02 \pm 0.12$
3	V	160	23.09	$17.86 \pm 0.08$	$14.66 \pm 0.19$
4	U	75	10.82	$10.0 \pm 0.09$	$6.58 \pm 0.12$
4	V	240	34.64	$26.83 \pm 0.17$	$19.55 \pm 0.28$
5	U	75	10.82	$10.01 \pm 0.34$	$6.53 \pm 0.22$
5	V	240	34.64	$26.84 \pm 0.26$	$18.77 \pm 0.43$
6	U	75	10.82	$11.56\pm0.51$	$8.52 \pm 0.47$
6	V	240	34.64	$27.16\pm1.77$	$20.44 \pm 0.88$

Table 1: Spatial resolutions for different sensors of layer 3–6 for both U and V sides.

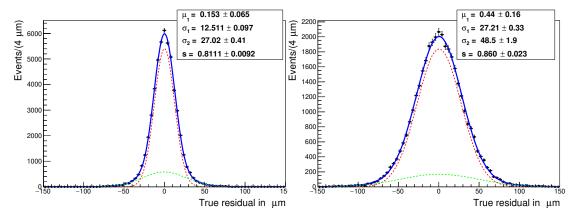


Figure 3: True residual distribution for the 6<sup>th</sup> layer U-side (left) and V-side (right) with cluster size one.

In figure 3 we show an example of the true residual distribution for the central sensor of the 6<sup>th</sup> layer, for clusters composed of a single strip.

The estimated spatial resolution for each layer of the SVD is listed in Table 1. The factor of 2 in the digital resolution expression takes into account that there is one floating strip between two readout strips. The spatial resolution for multistrip cluster is better than single-strip cluster. This is because the position of multistrip cluster is estimated not only with the strip position but also using the information of charge collected by the strip. Thanks to this additional information multistrip cluster attains a better spatial resolution than single-strip one. Further, we find that the spatial resolution for single-strip cluster is better than the digital resolution. This is because in the former case the cluster position is calculated using the additional information that the strips beside the fired one have signal-to-noise ratio below threshold. Smaller cluster position residuals on the U side reflect the smaller strip pitch as well as a better estimation of track parameters compared to the V side.

## 5. Summary

We have presented a Monte Carlo based study to estimate the spatial resolution of the SVD. The spatial resolution of the multistrip cluster is better than the single-strip cluster. Again, the spatial resolution of single-strip cluster better than the digital resolution. The overall resolution ranges from about 5  $\mu$ m in the U side to 20  $\mu$ m in the V side.

# 6. Acknowledgments

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